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Not all journals covered by *Current Contents* are published weekly. Therefore, in any given issue your favorite journal may not be listed. However, it will be included as often as it is issued. For the complete List of Serials covered and the latest Publisher Guide see issue #30, July 28, 1997. For the latest Triannual Cumulative Index see issue #21, May 26, 1997.

FEATURED IN THIS ISSUE OF CURRENT CONTENTS®/ENGINEERING, COMPUTING & TECHNOLOGY

FEATURES

- 5 Current Book Contents®
- 8 Journal Coverage Changes

DISCIPLINE GUIDE

- 9 Aerospace Engineering
- 10 AI, Robotics & Automatic Control
- 14 Chemical Engineering
- 40 Civil Engineering
- 47 Computer Engineering, Technology & Applications
- 53 Electrical and Electronics Engineering
- 70 Engineering Management/General
- 74 Engineering Mathematics
- 75 Environmental Engineering/Energy

- 80 Geological/Petroleum/Mining Engineering
- 81 Information Technology & Communications Systems
- 89 Instrumentation/Measurement
- 91 Materials Science and Engineering
- 110 Mechanical Engineering
- 122 Metallurgy
- 127 Nuclear Engineering
- 132 Optics & Acoustics

INDEXES

- 144 Title Word Index
- 177 Author Index & Address Directory
- 196 Publishers Address Directory

Current Contents processes all journal issues within two weeks of their receipt and makes every reasonable effort to insure their prompt delivery to ISI. Please note that the cover dates of some journals do not correspond to the actual publication dates.

If a journal is covered in more than one *CC*®, a letter code appears in parentheses next to the volume and issue number to identify which editions: (L)=Life Sciences; (P)=Physical, Chemical & Earth Sciences; (S)=Social & Behavioral Sciences; (A)=Agriculture, Biology & Environmental Sciences; (C)=Clinical Medicine; (E)=Engineering, Computing & Technology; (H)=Arts & Humanities.

JOURNALS APPEARING IN THIS ISSUE:

- | | | | |
|-----|---------------------------------------|-----|---------------------------------------|
| 47 | ACM COMPUT SURV,29 (2) | 70 | COMPUT OPER RES,24 (10) |
| 122 | ACTA MATER,45 (8) | 111 | COMPUTATION MECH,20 (1-2) |
| 14 | ADV POLYM TECHNOL,16 (3) | 92 | CORROS SCI,39 (8) |
| 9 | AIAA J,35 (8) | 49 | DES AUTOM EMBED SYST,2 (3-4) |
| 81 | ALCATEL TELECOMMUN REV,1997 (2) | 92 | DIAMOND FILM TECHNOL,7 (1) |
| 75 | AMBIO,26 (4) | 53 | DIGIT SIGNAL PROCESS,7 (3) |
| 14 | APPL CATAL A-GEN,155 (2) | 136 | EARTH OBSERVATION REMOTE SENS,14 (3) |
| 74 | APPL MATH MODEL,21 (7) | 41 | EARTHQUAKE ENG STRUC DYNAM,26 (8) |
| 132 | APPL OPT,36 (22) | 54 | EDN,42 (16) |
| 135 | APPL OPT,36 (23) | 55 | ELEC POWER SYST RES,42 (3) |
| 89 | APPL SPECTROSC,51 (7) | 82 | ELECTRON COMMUN JPN I,80 (7) |
| 110 | ARCH RATION MECH ANAL,138 (2) | 55 | ELECTRON COMMUN JPN II,80 (1) |
| 127 | AT ENERGY-ENGL TR,82 (1) | 56 | ELECTRON COMMUN JPN III,80 (7) |
| 10 | AUTOMAT REMOTE CONTR-ENGL TR,58 (1)P2 | 56 | ELECTRON ENG-LONDON,69 (842) |
| 11 | AUTOMAT REMOTE CONTR-ENGL TR,58 (2)P1 | 57 | ELECTRON PROD MAG,40 (3) |
| 14 | CHEM ENG LONDON,1997 (638) | 75 | ENVIRON SCI TECHNOL,31 (8) |
| 15 | CHEM ENG SCI,52 (16) | 74 | EUR J APPL MATH,8 (JUN)P3 |
| 18 | CHEM WEEK,159 (13) | 112 | EXP TECH,21 (4) |
| 19 | CHEM WEEK,159 (14) | 93 | FATIGUE FRACT ENG MATER STRUC,20 (7) |
| 21 | CHEM WEEK,159 (15) | 33 | FUEL,76 (10) |
| 23 | CHEM WEEK,159 (17) | 57 | FUJITSU SCI TECH J,33 (1)SI |
| 24 | CHEM WEEK,159 (20) | 128 | FUSION ENG DES,36 (1) |
| 26 | CHEM WEEK,159 (21) | 128 | FUSION ENG DES,36 (2-3) |
| 27 | CHEM WEEK,159 (23) | 129 | FUSION TECHNOL,32 (1) |
| 29 | CHEM WEEK,159 (24) | 78 | GEOTHERMICS,26 (4) |
| 30 | CHEM WEEK,159 (25) | 78 | HAZARDOUS WASTE CONSULTANT,15 (4) |
| 16 | CHEM WEEK,159 (8) | 33 | HYDROCARB PROCESS,76 (7) |
| 32 | CHEMTECH,27 (8) | 57 | IEE PROC-GENER TRANSM DISTRIB,144 (4) |
| 40 | CHINA OCEAN ENG,11 (1) | 10 | IEEE AEROSP ELECT SYST MAG,12 (8) |
| 40 | CIVIL ENG,67 (8) | 42 | IEEE J OCEANIC ENG,22 (3) |
| 110 | COMBUST FLAME,110 (4) | 82 | IEEE J SEL AREA COMMUN,15 (6) |
| 47 | COMMUN ACM,40 (8) | 49 | IEEE MICRO,17 (4) |
| 91 | COMPOS STRUCT,37 (1) | 58 | IEEE SIGNAL PROCESS LETT,4 (8) |
| 91 | COMPOSITES SCI TECHNOL,57 (7) | 83 | IEEE TRANS ANTENNAS PROPAGAT,45 (8) |
| 48 | COMPUT AIDED GEOM DESIGN,14 (6) | 58 | IEEE TRANS CIRC SYST VIDEO T,7 (4) |
| 82 | COMPUT COMMUN,20 (4) | 59 | IEEE TRANS CIRCUIT SYST-1,44 (8) |
| 48 | COMPUT GRAPH,21 (3) | 93 | IEEE TRANS COMPON PACK MAN B,20 (3) |
| 110 | COMPUT METHOD APPL MECH ENG,148 (1-2) | 50 | IEEE TRANS COMPUT,46 (7) |

CONTINUED

- 60 IEEE TRANS EDUC,40 (3)
 60 IEEE TRANS ELECTRON DEVICES,44 (8)
 61 IEEE TRANS IND ELECTRON,44 (4)
 50 IEEE TRANS PARALL DISTRIB SYS,8 (7)
 11 IEEE TRANS ROBOTICS AUTOMAT,13 (4)
 62 IEEE TRANS SEMICONDUCT MANUF,10 (3)
 62 IEEE TRANS SIGNAL PROCESS,45 (8)
 51 IEEE TRANS SOFTWARE ENG,23 (6)
 84 IEICE TRANS COMMUN,E80B (7)
 63 IEICE TRANS ELECTRON,E80C (7)
 65 IEICE TRANS FUND ELEC COM COM,E80A (7)
 85 IEICE TRANS INFORM SYST,E80D (7)
 12 IND ROBOT,24 (3)
 34 INDIAN J CHEM TECHNOLOGY,4 (4)
 85 INFORM COMPUT,136 (2)
 85 INFORM SCIENCES,98 (1-4)
 112 INT APPL MECH-ENGL TR,32 (10)
 113 INT APPL MECH-ENGL TR,32 (11)
 12 INT J ADAPT CONTROL SIGNAL PR,11 (5)
 51 INT J COMPUT APPL TECHNOL,10 (3-4)
 13 INT J COMPUT VISION,23 (3)
 13 INT J CONTR,67 (5)
 66 INT J ELECTRON,83 (2)
 79 INT J ENERG RES,21 (9)
 52 INT J GEN SYSTEM,26 (1-2)
 66 INT J MICROWAVE MILLIMETER-W,7 (5)
 74 INT J NUMER METHOD ENG,40 (16)
 113 INT J NUMER METHOD FLUID,25 (3)
 114 INT J PRESSURE VESSELS PIPING,72 (1)
 70 INT J PROD RES,35 (8)
 114 INT J SOLIDS STRUCT,34 (25)
 86 INTERNET RES,7 (3)
 52 J ACM,44 (2)
 94 J ADHES SCI TECHNOL,11 (7)
 79 J AGR ENG RES,67 (3)
 97 J APPL POLYM SCI,65 (10)
 95 J APPL POLYM SCI,65 (7)
 96 J APPL POLYM SCI,65 (8)
 96 J APPL POLYM SCI,65 (9)
 130 J ATOM ENERG SOC JPN,39 (7)
 98 J COATING TECHNOL,69 (870)
 99 J COMPOS MATER,31 (14)
 114 J FLUID MECH,342 (JUL 10)
 42 J HYDROL,198 (1-4)
 79 J INST ENERG,70 (483)
 115 J JPN SOC TRIBOLOGIST,42 (6)
 52 J LOGIC PROGRAM,33 (1)
 99 J MATER ENG PERFORM,6 (4)
 116 J MATER PROCESS TECHNOL,68 (1)
 100 J MATER SCI,32 (15)
 101 J MATER SCI LETT,16 (15)
 102 J MATER SCI-MATER ELECTRON,8 (4)
 116 J MECH PHYS SOLIDS,45 (8)
 34 J MEMBRANE SCI,130 (1-2)
 36 J MEMBRANE SCI,131 (1-2)
 36 J MEMBRANE SCI,132 (1)
 117 J NON-NEWTONIAN FLUID MECH,71 (3)
 117 J NON-NEWTONIAN FLUID MECH,72 (1)
 103 J NONDESTRUCT EVAL,16 (1)
 103 J NONDESTRUCT EVAL,16 (2)
 130 J NUCL SCI TECHNOL,34 (6)
 71 J OPER RES SOC,48 (8)
 136 J OPT SOC AM B-OPT PHYSICS,14 (8)
 138 J OPT TECHNOL-ENG TR,64 (6)
 71 J QUAL TECHNOL,29 (3)
 103 J REINF PLAST COMPOSITE,16 (11)
 37 J SOC DYERS COLOUR,113 (7-8)
 139 J SOUND VIB,204 (4)
 139 J SOUND VIB,204 (5)
 67 J VLSI SIGNAL PROCESS SYST S,16 (2-3)
 37 JOCCA-SURF COATING INT,80 (7)
 117 JSME INT J C,40 (2)
 119 KSME INT J,11 (4)
 103 KUNSTST-PLAST EUR,87 (7)
 72 KUWAIT J SCI ENG,24 (1)
 104 MATER CHARACT,38 (3)
 105 MATER CHEM PHYS,49 (3)
 119 MECH ENG,119 (8)
 53 MULTIMED TOOLS APPL,4 (1)
 43 NAV ENG J,109 (3)
 13 NEUROCOMPUTING,16 (2)
 140 NOISE CONTR ENG J,45 (3)
 120 NONLINEAR DYNAMICS,13 (3)
 121 NONLINEAR DYNAMICS,13 (4)
 131 NUCL ENG INT,42 (516)
 132 NUCL SCI ENG,126 (3)
 80 OIL GAS J,95 (30)
 140 OPT FIBER TECHNOL,3 (1)
 141 OPT FIBER TECHNOL,3 (2)
 141 OPTICS LETTERS,22 (16)
 105 PLAST ENG,53 (7)
 106 POLYM ENG SCI,37 (7)
 123 POWD METALL MET CERAM ENGL-TR,35 (9-10)
 106 POWDER TECHNOL,92 (2)
 67 POWER,141 (4)
 68 PROC IEEE,85 (7)
 45 PROC INST CIVIL ENG-WATER MAR,124 (2)
 121 PROC INST MECH ENG PT E-J P M,211 (E2)
 37 PRZEM CHEM,76 (6)
 107 PULP PAP CAN,98 (7)
 86 RADIOTEKH ELEKTRON,42 (7)
 88 RAIRO-INFORM THEOR APPL,31 (2)
 73 RAIRO-RECH OPER-OPER RES,31 (3)
 73 RELIAB ENG SYST SAFETY,57 (2)
 80 RESOUR CONSERV RECYCL,20 (3)
 124 REV METALL-CAH INF TECH,94 (6)
 107 RUSS J NONDESTRUCT T-ENGL TR,32 (12)
 124 SCRIPTA MATER,37 (4)
 90 SENSOR ACTUATOR A-PHYS,58 (2)
 53 SIAM J COMPUT,26 (4)
 88 SIGNAL PROCESS,59 (3)
 88 SMPTE J,106 (8)
 38 SOAP COSMETIC CHEM SPEC,73 (7)
 80 SOLAR ENERG,60 (6)
 108 SOLAR ENERG MATER SOLAR CELLS,46 (4)
 69 SOLID STATE TECHNOL,40 (8)
 125 STAHL EISEN,117 (7)
 46 STRUCT ENG MECH,5 (4)
 108 SURF COAT TECH,92 (3)
 73 TECHNOVATION,17 (7)
 89 TELECOMMUN POLICY,21 (6)
 38 TENSIDE SURFACTANTS DETERG,34 (3)
 126 TETSU TO HAGANE,83 (8)
 109 TEXT RES J,67 (8)
 39 THEOR FOUND CHEM ENGINEERING,31 (4)
 121 TRANS CAN SOC MECH ENG,21 (2)
 69 VLSI DES,5 (3)
 46 WATER RESOUR RES,33 (8)
 142 WAVE MOTION,26 (1)
 126 WELD J,76 (8)
 143 ZH NAUCH PRIKL FOTOGRAF,42 (3)
 109 ZKG INT,50 (6)

The publisher's name appears with the journal title of each contents page. The address of each publisher is provided at the end of this issue.